IRF520

Vishay Siliconix



TO-220AB

PRODUCT SUMMARY

V_{DS} (V)

R_{DS(on)} (Ω)

Q_{gs} (nC)

Q_{gd} (nC)

Q_a max. (nC)

Configuration

Power MOSFET

S

N-Channel MOSFET

0.27

100

16

4.4

7.7

Single

 $V_{GS} = 10 V$

FEATURES

- Dynamic dV/dt rating
- · Repetitive avalanche rated
- 175 °C operating temperature
- Fast switching
- Ease of paralleling
- Simple drive requirements
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

Note

* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION				
Package	TO-220AB			
Lead (Pb)-free	IRF520PbF			
Lead (Pb)-free and halogen-free	IRF520PbF-BE3			

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER		SYMBOL	LIMIT	UNIT		
Drain-source voltage		V _{DS}	100	V		
Gate-source voltage		V _{GS}	± 20	V		
Continuous drain current	V _{GS} at 10 V	T _C = 25 °C T _C = 100 °C		9.2		
Continuous drain current		T _C = 100 °C	ID	6.5	A	
Pulsed drain current ^a			I _{DM}	37		
Linear derating factor			0.40	W/°C		
Single pulse avalanche energy ^b		E _{AS}	200	mJ		
Repetitive avalanche current ^a		I _{AR}	9.2	А		
Repetitive avalanche energy ^a			E _{AR}	6.0	mJ	
Maximum power dissipation	T _C = 25 °C		PD	60	W	
Peak diode recovery dV/dt ^c		dV/dt	5.5	V/ns		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +175	°C		
Soldering recommendations (peak temperature) ^d	For 10 s			300	1	
Mounting torque	6-32 or M3 screw			10	lbf ∙ in	
				1.1	N · m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. V_{DD} = 25 V, starting T_J = 25 °C, L = 3.5 mH, R_g = 25 Ω , I_{AS} = 9.2 A (see fig. 12)

c. $I_{SD} \leq 9.2$ A, $dI/dt \leq 110$ A/µs, $V_{DD} \leq V_{DS}, \, T_J \leq 175 \ ^\circ C$

d. 1.6 mm from case

S21-0819-Rev. C, 02-Aug-2021

1

Document Number: 91017



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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum junction-to-ambient	R _{thJA}	-		62				
Case-to-sink, flat, greased surface	R _{thCS}	0.50 - - 2.5			°C/W			
Maximum junction-to-case (drain)	R _{thJC}							
SPECIFICATIONS (T _J = 25 $^{\circ}$ C, U	nless otherw	ise noted)						
PARAMETER	SYMBOL	TEST	CONDITI	ONS	MIN.	TYP.	MAX.	UNIT
Static								
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0$	$V, I_D = 2$	50 µA	100	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference t	o 25 °C,	I _D = 1 mA	-	0.13	-	V/°C
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{CS}$	_{GS} , I _D = 2	50 µA	2.0	-	4.0	V
Gate-source leakage	I _{GSS}	V _G	_S = ± 20 '	V	-	-	± 100	nA
Zero gate voltage drain current	I	V _{DS} = 10	00 V, V _{GS}	; = 0 V	-	-	25	
Zero gate voltage drain current	IDSS	V _{DS} = 80 V, V	_{GS} = 0 V,	T _J = 150 °C	-	-	250	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	۱ _с	= 5.5 A ^b	-	-	0.27	Ω
Forward transconductance	9 _{fs}	V _{DS} = 50) V, I _D = {	5.5 A ^b	2.7	-	-	S
Dynamic								
Input capacitance	C _{iss}	V	_{GS} = 0 V,		-	360	-	
Output capacitance	C _{oss}	V	_{os} = 25 V		-	150	-	pF
Reverse transfer capacitance	C _{rss}	f = 1.0 MHz, see fig. 5		-	34	-		
Total gate charge	Qg				-	-	16	
Gate-source charge	Q _{gs}			2 A, V _{DS} = 80 V, fig. 6 and 13 ^b	-	-	4.4	nC
Gate-drain charge	Q _{gd}			•	-	-	7.7	
Turn-on delay time	t _{d(on)}				-	8.8	-	
Rise time	t _r	V _{DD} = 5	0 V, I _D =	9.2 A,	-	30	-	
Turn-off delay time	t _{d(off)}	$V_{DD} = 50 \text{ V}, \text{ I}_D = 9.2 \text{ A},$ $R_g = 18 \Omega, R_D = 5.2 \Omega, \text{ see fig. 10 }^{\text{b}}$		-	19	-	ns	
Fall time	t _f			-	20	-		
Gate input resistance	R _g	f = 1 MHz, open drain		1.0	-	5.0	Ω	
Internal drain inductance	L _D	Between lea 6 mm (0.25") f	rom		-	4.5	-	
Internal source inductance	L _S	die contact		-	7.5	-	nH	
Drain-Source Body Diode Characteristic	s							
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		9.2	A			
Pulsed diode forward current ^a	I _{SM}			-	-	37	~	
Body diode voltage	V_{SD}	T _J = 25 °C, I _S	= 9.2 A,	V _{GS} = 0 V ^b	-	-	1.8	V
Body diode reverse recovery time	t _{rr}	– T _J = 25 °C, I _F = 9			-	110	260	ns
Body diode reverse recovery charge	Q _{rr}	ij – 23 0, i _F = 8	ייד א, ui/u	αι – 100 Ανμδ [∞]	-	0.53	1.3	μC
Forward turn-on time	t _{on}	Intrinsic turn	Intrinsic turn-on time is negligible (turn-o		-on is doi	minated by L_S and L_D)		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width \leq 300 µs; duty cycle \leq 2 %

2

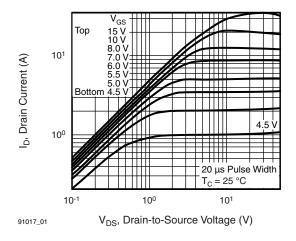
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





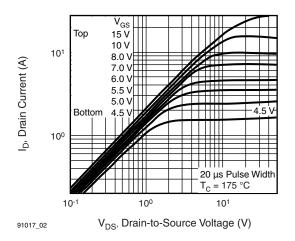
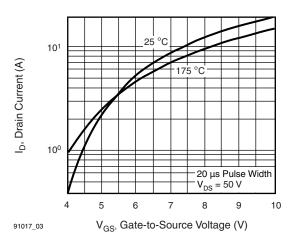


Fig. 2 - Typical Output Characteristics, T_C = 175 °C





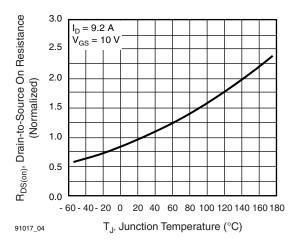


Fig. 4 - Normalized On-Resistance vs. Temperature

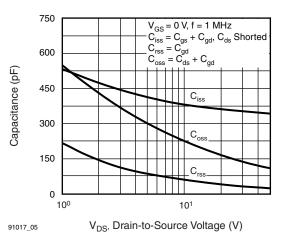


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

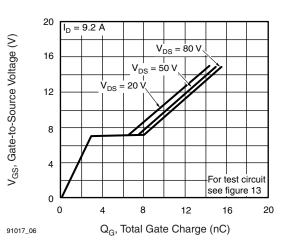


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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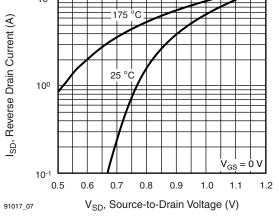


Fig. 7 - Typical Source-Drain Diode Forward Voltage

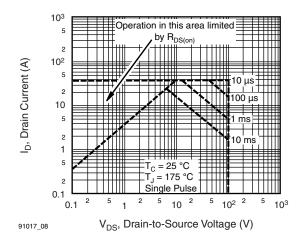


Fig. 8 - Maximum Safe Operating Area

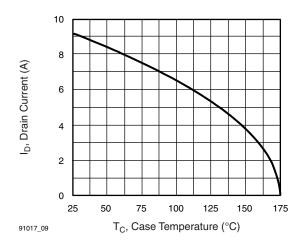


Fig. 9 - Maximum Drain Current vs. Case Temperature

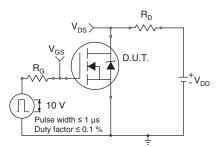


Fig. 10a - Switching Time Test Circuit

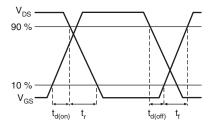
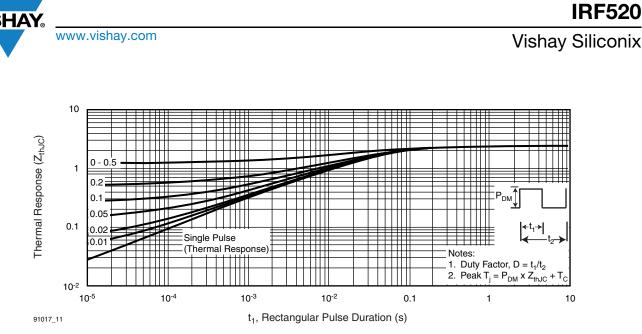


Fig. 10b - Switching Time Waveforms





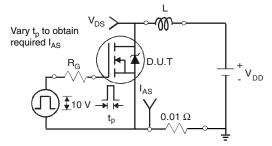
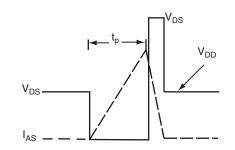
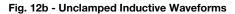


Fig. 12a - Unclamped Inductive Test Circuit





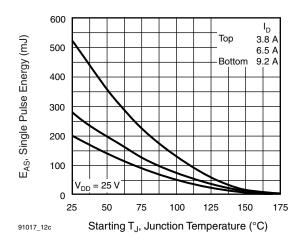


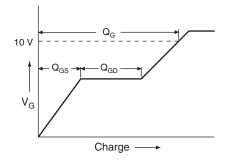
Fig. 12c - Maximum Avalanche Energy vs. Drain Current

5



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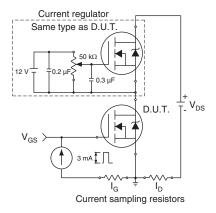
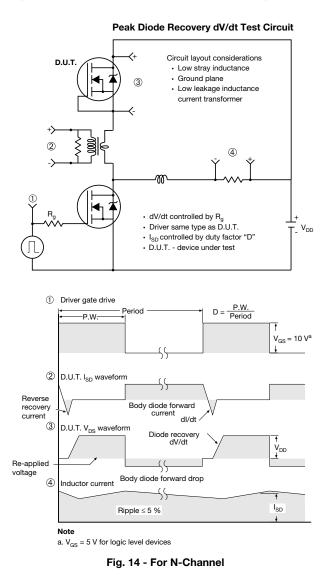


Fig. 13a - Basic Gate Charge Waveform





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TO-220-1



DIM	MILLIN	METERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

Note

• M* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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